

ASSIGNMENT

WHEREAS,

1. Ching-Sheng Yang	2. Su-Hua Wu
3. Shu-Chen Wang	4. Chien-Ming Lin

Hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: **TRANSFORMER MODULE**

[] Filed: Serial No.
[X] Executed concurrently with the execution of this instrument

WHEREAS, **TAIPEI MULTIPOWER ELECTRONICS CO., LTD.**

**2nd. F1., 542-27, Chung-Cheng Road., Hsin-Tien City, Taipei Hsien,
Taiwan, R.O.C.**

Hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same.

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do self, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

YANG CHING SHENG

Signature:

Sole or First Joint Inventor: Ching-Sheng Yang

July 1, 2004

Date:

Wu Su Hua

Signature:

Second Joint Inventor (if any): Su-Hua Wu

July 1, 2004

Date:

WANG SHU CHEN

Signature:

Third Joint Inventor (if any): Shu-Chen Wang

July 1, 2004

Date:

Lin chien Ming

Signature:

Fourth Joint Inventor (if any): Chien-Ming Lin

July 1, 2004

Date: